



RoHS Compliant

**MAX
260°C**

**MSL
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit 225.90	ppm
752 20 DRT	Alumina Ceramic	Al2O3	0.8800	0.1988	87.50%	173.9430	77.00%	770000
		SiO2 (silicon dioxide)			12.50%	24.8490	11.00%	110000
					100.00%	198.7920		
Conductor Thick Film	Ag	7440-22-4	0.0068	0.0015	100.00%	1.5361	0.68%	6800
					100.00%	1.5361		
Resistor Thick Film	RuO2	12036-10-1	0.0079	0.0018	30.00%	0.5354	0.24%	2370
	PbO	1317-36-8			10.00%	0.1785	0.08%	790
	SiO2 (silicon dioxide)	14808-60-7			30.00%	0.5354	0.24%	2370
	B2O3	1303-86-2			30.00%	0.5354	0.24%	2370
					100.00%	1.7846		
Notch Conductor Thick Film	Ag	7440-22-4	0.0113	0.0026	100.00%	2.5527	1.13%	11300
					100.00%	2.5527		
Underplate	Ni	7440-02-0	0.0250	0.0056	100.00%	5.6475	2.50%	25000
					100.00%	5.6475		
Finish Plate	Sn	7440-31-5	0.0170	0.0038	100.00%	3.8403	1.70%	17000
					100.00%	3.8403		
Covercoat	TiO2	13463-67-7	0.0520	0.0117	50.00%	5.8734	2.60%	26000
	Silicone	218163-11-2			50.00%	5.8734	2.60%	26000
		Sum	1.0000	0.2259	100.00%	11.7468		
			part weight	0.2259				
		Totals:		0.2259		225.90	100.00%	1000000

RoHS exemption claimed for lead in glass of electronic component